

# NeoPress High-Speed Mezzanine System

**molex**<sup>®</sup>

**Modular NeoPress High-Speed Mezzanine System enables design flexibility on space-constrained PCBs with tunable differential pairs, low stack heights and compliant-pin terminations while offering data rates up to 28 Gbps**

## Features and Benefits

**Patent-pending modular triad wafer design offers high-speed differential pairs that can be tuned to 85- or 100-Ohm impedances**

Provides a customized system for design flexibility



**High-speed triad wafers comprise three pins per differential pair (two signal pins and one shielded ground pin)**

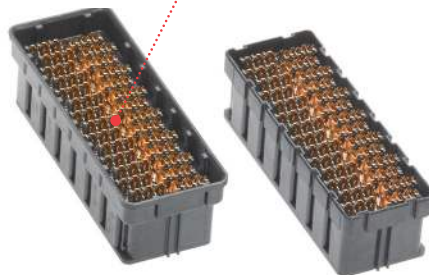
Provide standalone 28+ Gbps fully shielded differential pairs with dedicated grounds



NeoPress<sup>®</sup> High-Speed Mezzanine System  
SystemTop: Plug, Bottom: Receptacle  
6-by-14 (84 triads)

**Proven Impel press-fit compliant-pin termination design with data rates up to 28 Gbps**

Enables solderless termination with easy board rework without sacrificing data speed



**Connectors feature a density of 76 differential pairs / triad per square inch**

Offers ultra-high-density press-fit signal solution with optimal signal integrity performance

**Options include four triad configurations, high-speed single-ended traces, low-speed single-ended lines and power contacts**

Offers real-estate savings on PCB by supporting requirements for low- and high-speed signals and power within one compact connector



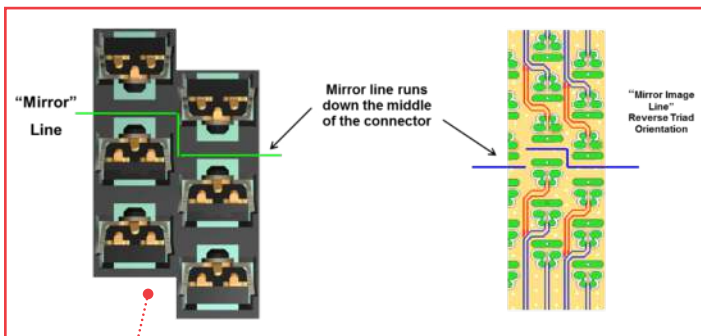
**Durable housing material**

Delivers a robust system with mechanical stability



**Ground plate on upper and lower housings**

Minimizes crosstalk. Provides added alignment for pin stitching



**Reliable mating interface with 1.50mm wipe**

Sufficient conductive wipe for clean signal transmission and enhanced performance

**Hermaphroditic interface ensures that the receptacle beams are protected by the plug and shield contacts**

Prevents terminal damage by protecting the mating contact interface

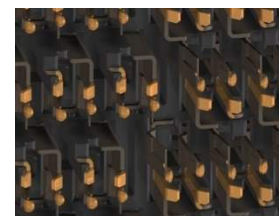
**Mirror-image triad layout**

Simplifies PCB routing. Lowers system costs by decreasing the number of PCB layers required for signal routing



**Available in 9.00 to 45.00mm mated stack heights**

Addresses engineering constraints in system envelopes



**Staggered footprint within connector**

Ensures zero-skew routing and minimized crosstalk

# NeoPress High-Speed Mezzanine System



## Applications

### Telecommunication / Networking

- Hubs
- Servers
- NAS Towers
- Rack Mount Servers

### Industrial Automation

- Controller Personality Cards

### Medical



Industrial Controller



Servers



Network Interface Cards /  
Modules on a Rack

## Specifications

### REFERENCE INFORMATION

Packaging: Tray  
 Mates With: NeoPress 100-Ohm Vertical Plug (Series [172801](#)) mates with NeoPress 100-Ohm Vertical Receptacle (Series [172832](#)); NeoPress 85-Ohm Vertical Plug (Series [203341](#)) mates with NeoPress 85-Ohm Vertical Receptacle (Series [203340](#))  
 Designed In: Millimeters  
 RoHS: Yes  
 Halogen Free: Yes

### ELECTRICAL

Voltage (max.): 30V AC RMS  
 Current (max.): 1.0A  
 Contact Resistance (max.): 10 milliohms  
 Dielectric Withstanding Voltage: 200V AC RMS  
 Insulation Resistance (min.): 1000 Megohms

### MECHANICAL

Mating Force (max.): 0.75N  
 Unmating Force (min.): 0.25N  
 Durability (min.): 100 cycles

### PHYSICAL

Housing: High-Temperature LCP  
 Contact: Copper (Cu)  
 Plating:  
 Contact Area — 30µ" Gold (Au)  
 Compliant Pin Area — Selective Tin (Sn) over 50µ"  
 Nickel (Ni) Overall  
 Operating Temperature: -55 to +85°C

## Ordering Information

### PLUG

Series No.	Impedance (Ohms)	Plating	Connector Height	Triad Wafer Configuration (row-by-column)
<a href="#">172801</a>	100	0.762µ (30µ") Gold	4.50 to 22.50mm	Easily support grids 2-by-4 to 10-by-30
<a href="#">203341</a>	85			

### RECEPTACLE

Series No.	Impedance (Ohms)	Plating	Connector Height	Triad Wafer Configuration (row-by-column)
<a href="#">172832</a>	100	0.762µ (30µ") Gold	4.50 to 22.50mm	Easily support grids 2-by-4 to 10-by-30
<a href="#">203340</a>	85			

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